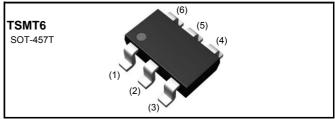


V _{DSS}	30V
R _{DS(on)} (Max.)	134mΩ
I _D	2.0A
P _D	1.25W

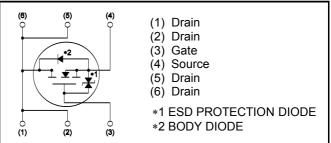
Features

- 1) Low on resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TSMT6).
- 4) Pb-free lead plating ; RoHS compliant

Outline



Inner circuit



Packaging specifications

Туре	Packaging	Taping
	Reel size (mm)	180
	Tape width (mm)	8
	Basic ordering unit (pcs)	3,000
	Taping code	TR
	Marking	QQ

Application

DC/DC converters

• Absolute maximum ratings $(T_a = 25^{\circ}C)$

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	30	V
Continuous drain current	ا _D *1	±2.0	A
Pulsed drain current	I _{D,pulse} *2	±8.0	A
Gate - Source voltage	V _{GSS}	±20	V
Dower dissipation	P _D *3	1.25	W
Power dissipation	P _D ^{*4}	0.6	W
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

RSQ020N03

Thermal resistance

Parameter	Symbol	Values			Unit
Faranieter	Symbol	Min.	Тур.	Max.	Offic
Thermal resistance, junction - ambient	R_{thJA} *3	-	-	100	°C/W
	R_{thJA} *4	-	-	208	°C/W

•Electrical characteristics($T_a = 25^{\circ}C$) ,unless otherwise specified

Deremeter	Symbol Conditions -		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	30	-	-	V
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}}$	I _D =1mA referenced to 25°C	-	26	-	mV/°C
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V	-	-	1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±10	μA
Gate threshold voltage	$V_{GS(th)}$	V _{DS} = 10V, I _D = 1mA	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{(GS)th}}{\Delta T_{j}}$	I _D =1mA referenced to 25°C	-	-2.8	-	mV/°C
		V _{GS} =10V, I _D =2.0A	-	96	134	
Static drain - source	D *5	V _{GS} =4.5V, I _D =2.0A	-	148	207	
on - state resistance	R _{DS(on)} ⁵	V _{GS} =4.0V, I _D =2.0A	-	168	235	mΩ
		V _{GS} =10V, I _D =2.0A, T _j =125°C	-	155	220	
Gate input resistannce	R_{G}	f = 1MHz, open drain	-	9.5	-	Ω
Transconductance	9 _{fs} *5	V _{DS} =10V, I _D =2.0A	1.5	3.0	-	S

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10 $\mu s,$ Duty cycle \leq 1%

- *3 Mounted on a ceramic board (30×30×0.8mm)
- *4 Mounted on a FR4 (15×20×0.8mm)

*5 Pulsed

•Electrical characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions		Unit			
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Onit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	110	-		
Output capacitance	C _{oss}	V _{DS} = 10V	-	40	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	22	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 15V, V_{GS} = 10V$	-	7	-		
Rise time	t _r *5	I _D = 1.0A	-	9	-	n 0	
Turn - off delay time	t _{d(off)} *5	R _L = 15.0Ω	-	16	-	ns	
Fall time	t _f *5	$R_G = 10\Omega$	-	4	-		

•Gate Charge characteristics($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_{a}^{*5}	V _{DD}	-	2.2	3.1	
		V _{DD}	-	4.5	-	nC
Gate - Source charge	Q_{gs}^{*5}	V _{DD} ≃ 15V, I _D =2.0A	-	0.7	-	
Gate - Drain charge	Q_{gd} *5	$V_{GS} = 5V$	-	0.6	-	

•Body diode electrical characteristics (Source-Drain)(T_a = 25°C)

Parameter	Symbol Conditions -		Values			Unit
Farameter			Min.	Тур.	Max.	Offic
Inverse diode continuous, forward current	ا _S *1	T _a = 25°C	-	-	1	А
Forward voltage	V_{SD} *5	V _{GS} = 0V, I _s = 1.0A	-	-	1.2	V

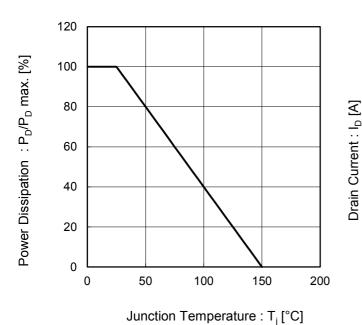


Fig.1 Power Dissipation Derating Curve

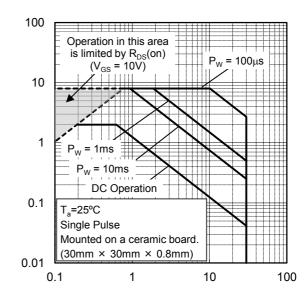
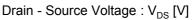


Fig.2 Maximum Safe Operating Area



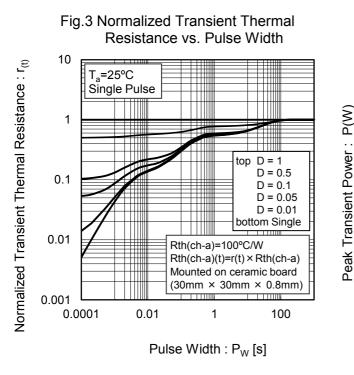
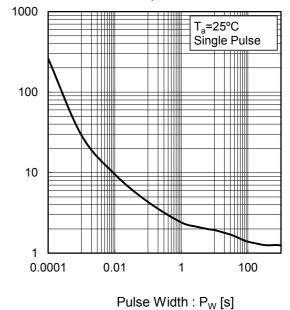


Fig.4 Single Pulse Maximum Power dissipation



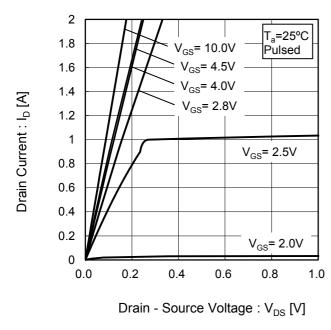


Fig.5 Typical Output Characteristics(I)

2 T_=25°C 1.8 Pulsed 1.6 V_{GS}= 10.0V 1.4 V_{GS}= 4.5V V_{GS}= 4.0V 1.2 1 V_{GS}= 2.5V 0.8 0.6 0.4 0.2 V_{GS}= 2.0V 0 0.0 2.0 4.0 6.0 8.0 10.0 Drain - Source Voltage : V_{DS} [V]

Fig.6 Typical Output Characteristics(II)



Fig.7 Breakdown Voltage vs. Junction Temperature

Drain - Source Breakdown Voltage : V_{(BR)DSS} [V]

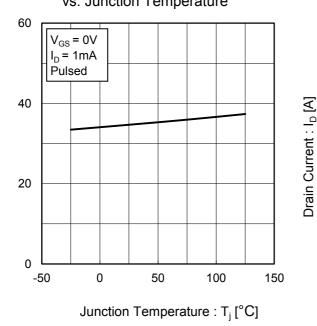
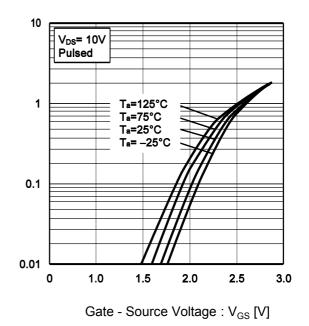


Fig.8 Typical Transfer Characteristics



Drain Current : I_D [A]

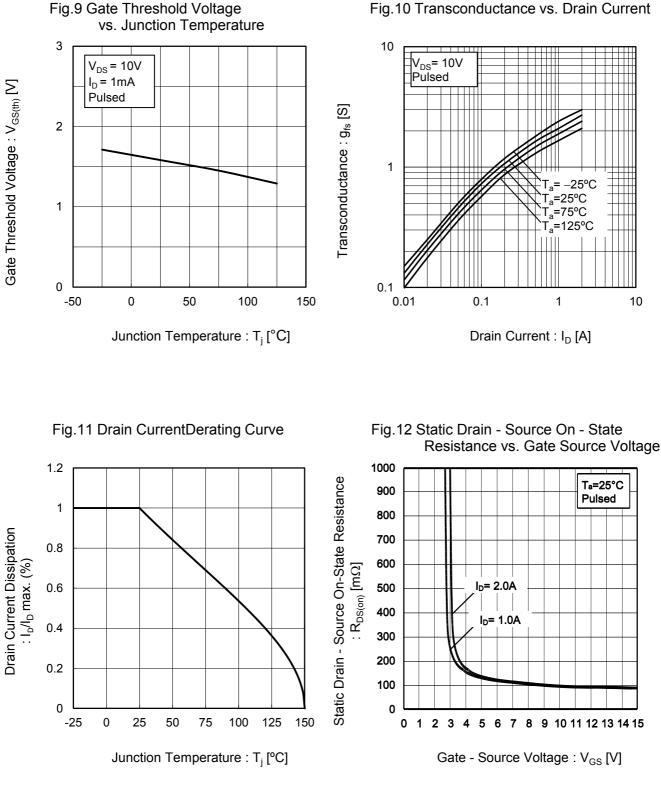
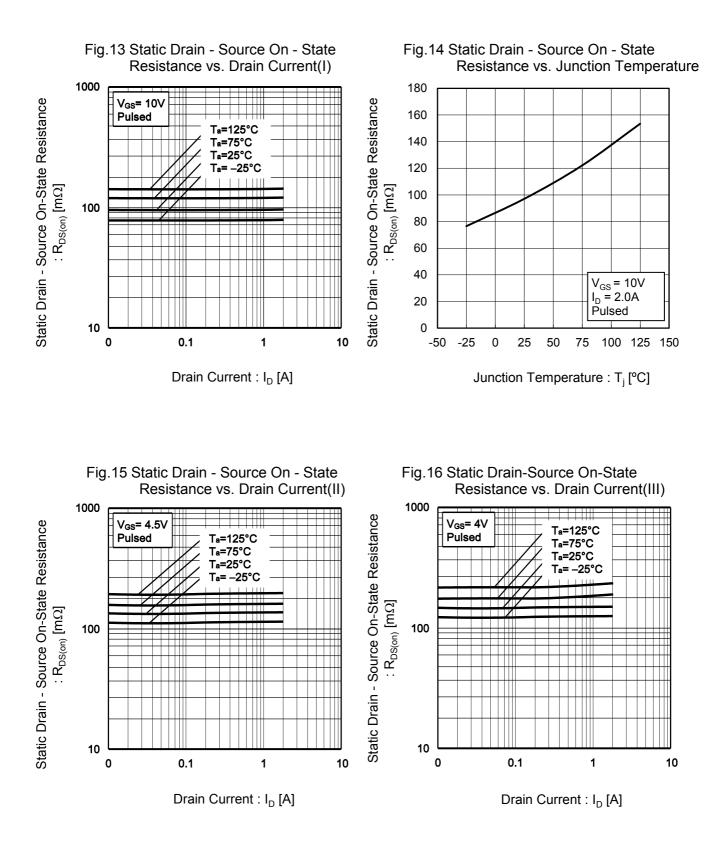


Fig.10 Transconductance vs. Drain Current



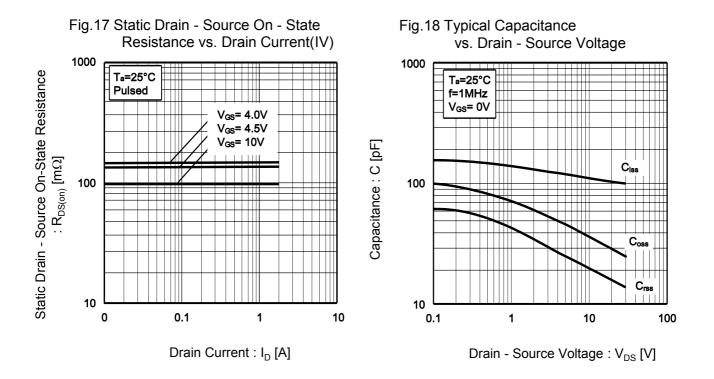


Fig.19 Switching Characteristics

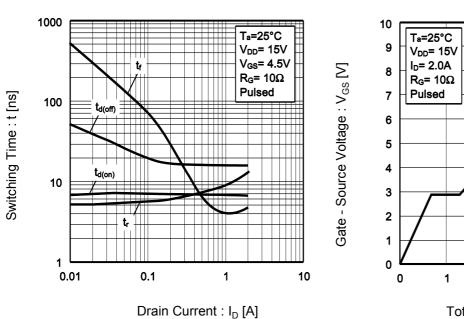
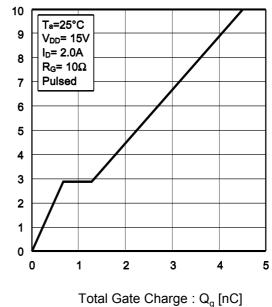
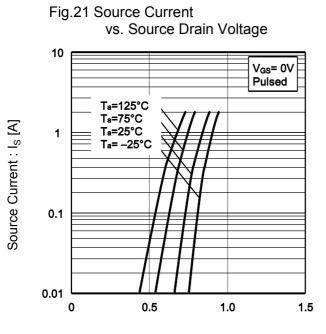


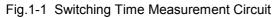
Fig.20 Dynamic Input Characteristics





Source-Drain Voltage : V_{SD} [V]

Measurement circuits



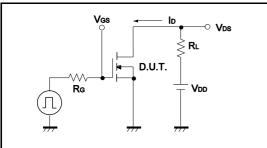


Fig.2-1 Gate Charge Measurement Circuit

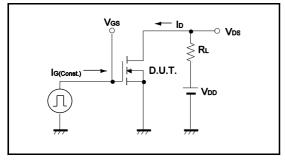
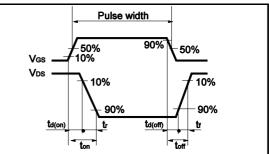
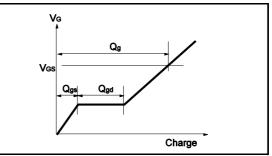


Fig.1-2 Switching Waveforms

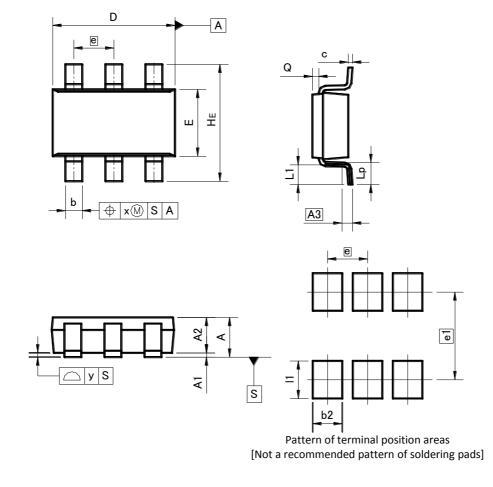






•Dimensions (Unit : mm)

TSMT6



DIM	MILIMETERS		INC	HES
DIN	MIN	MAX	MIN	MAX
A	-	1.00	-	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.2	25	0.0	10
b	0.35	0.50	0.014	0.020
с	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.9	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
x	_	0.20	_	0.008
У	_	0.10	_	0.004

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
b2		0.70	-	0.028
e1	2.10		0.0	83
1	_	0.90	_	0.035

Dimension in mm / inches

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